

2.4GHz 2012 Chip Antenna: RANT2012F245C02

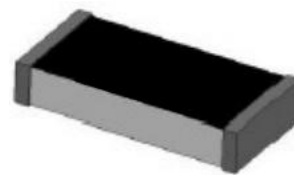


Application:

WLAN, 802.11b/g, Bluetooth, WLAN, etc...

Features

SMD, high reliability, ultra Impact, Omni-directional...



Part number Information

RANT 2012 F 245 C 02
(A) (B) (C) (D) (E) (F)

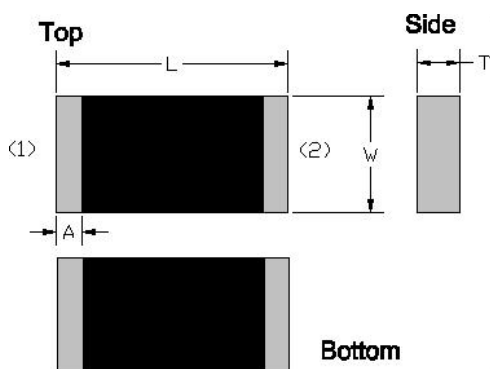
| | |
|------------------|-----------------------|
| (A)Product Type | Chip Antenna |
| (B) Size Code | 2.0x1.2mm(+/-0.2mm) |
| (C) Material | High K material |
| (D) Frequency | 2.4 ~ 2.5GHz |
| (E) Feeding mode | PIFA & Single Feeding |
| (F) Antenna type | Type=02 |

Electrical Specification

| | |
|-------------------------------|--------------------|
| Working Frequency Range | 2400 ~2484 MHz |
| Bandwidth | 84 (Min.) |
| Peak Gain | 1.95 dBi (Typ.) |
| Impedance | 50 Ohm |
| Return loss | 10 dB (Min) |
| Polarization | Linear |
| Azimuth Beamwidth | Omni-directional |
| Operation Temperature(°C) | -40 ~85°C |
| Resistance to Soldering Heats | 10sec. (@ 280°C) |
| Termination | Ni / Au (Leadless) |

The specification is defined on EVB.

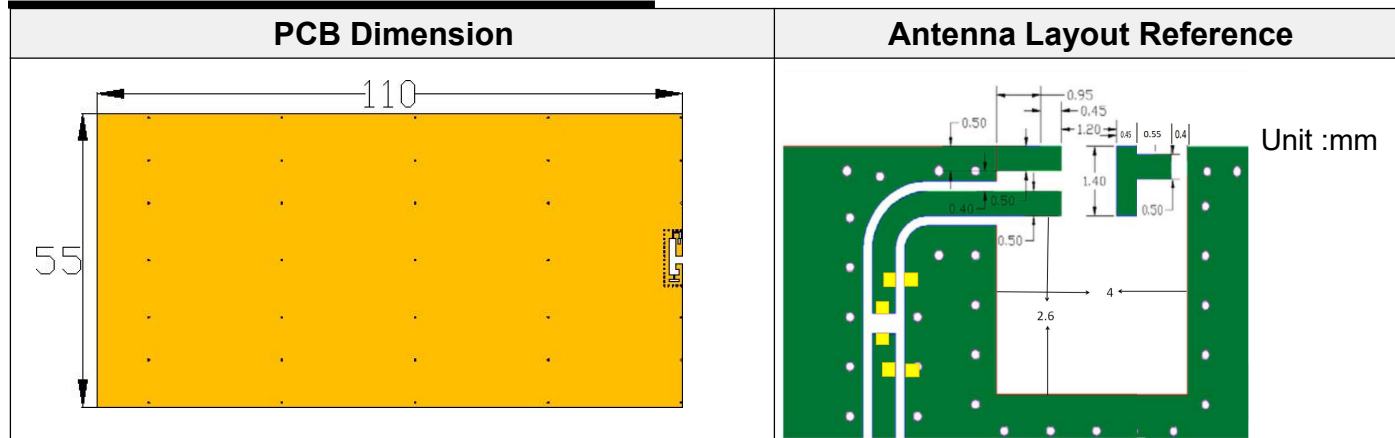
Dimension and Terminal Configuration



| Dimension (mm) | |
|----------------|-------------|
| L | 2.05+/-0.15 |
| W | 1.20+/-0.15 |
| T | 0.45+/-0.10 |

| No. | Terminal Name |
|-----|---------------|
| 1 | Feeding/GNG |
| 2 | GND |

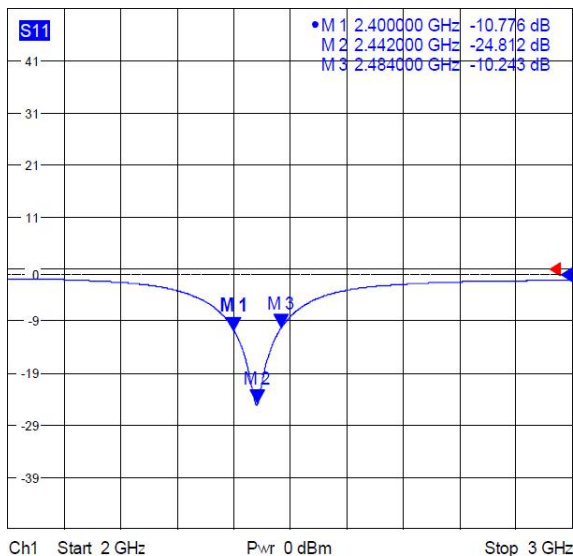
Evaluation Board Reference



Electrical Characteristics

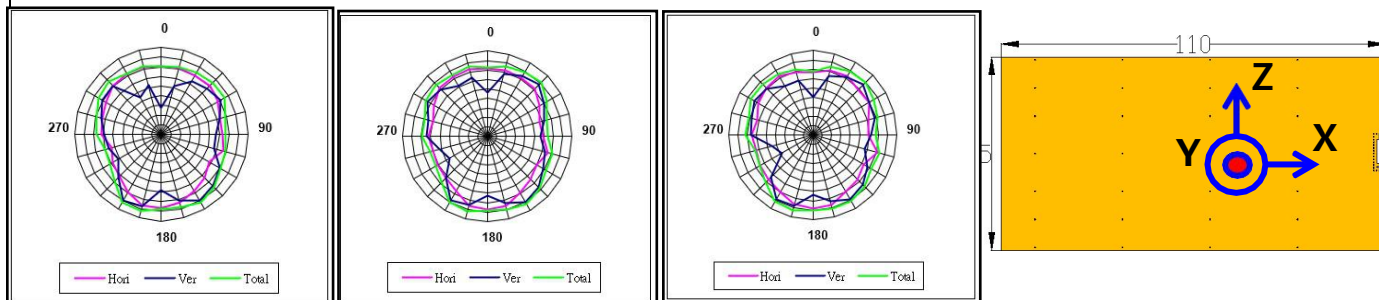
Return Loss & Radiation

Return Loss

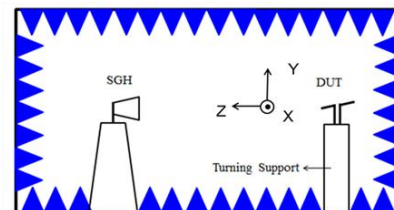


| Frequency(MHz) | S11 (dB) |
|----------------|----------|
| 2400 | -10.77 |
| 2450 | -24.81 |
| 2484 | -10.243 |

Radiation



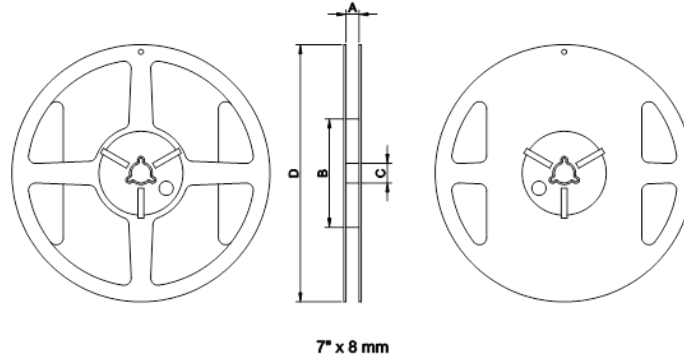
| | 2400MHz | 2450MHz | 2500MHz |
|-------------|----------|----------|----------|
| Efficiency | 70.56% | 75.25% | 71.01% |
| Peak Gain | 1.72 dBi | 1.95 dBi | 1.69 dBi |
| Directivity | 2.26 dBi | 2.69 dBi | 2.11 dBi |



Taping Specifications

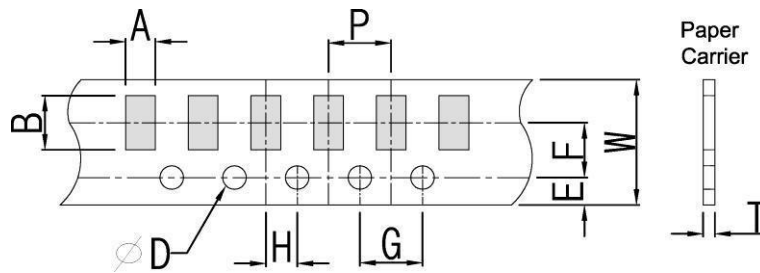
Reel and Taping Specification

Reel Specification



| TYPE | SIZE | | A | B | C | D |
|------|------|---------|---------|------|----------|-------|
| 2012 | 7" | 5K/Reel | 9.0±0.5 | 60±2 | 13.5±0.5 | 178±2 |

Taping Specification



| Packaging | Type | A | B | W | E | F | G | H | T | D | P |
|------------|------|-----------|-----------|----------|-----------|----------|----------|----------|-----------|-----------|---------|
| Paper Type | 2012 | 1.50±0.20 | 2.30±0.20 | 8.0±0.20 | 1.75±0.10 | 3.5±0.05 | 4.0±0.10 | 2.0±0.05 | 0.75±0.10 | 1.57±0.10 | 4.0±0.1 |

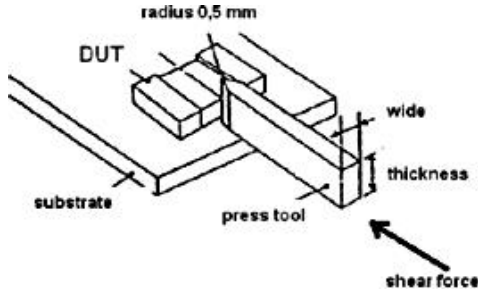
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Reliability Table

| Test Item | Procedure | Requirements Ceramic Type | Remark (Reference) |
|--|--|---|---------------------------|
| Electrical Characterization | | Fulfill the electrical specification | User Spec. |
| Thermal Shock | <ol style="list-style-type: none"> 1. Preconditioning: 50 ± 10°C / 1 hr , then keep for 24 ± 1 hrs at room temp. 2. Initial measure: Spec: refer Initial spec. 3. Rapid change of temperature test: -30°C to +85°C; 100 cycles; 15 minutes at Lower category temperature; 15 minutes at Upper category temperature. | No Visible Damage. Fulfill the electrical specification. | MIL-STD-202 107 |
| Temperature Cycling | <ol style="list-style-type: none"> 1. Initial measure: Spec: refer Initial spec. 2. 100 Cycles (-30°C to +85°C), Soak Mode=1(2 Cycle/hours). 3. Measurement at 24 ± 2Hours after test condition. | No Visible Damage. Fulfill the electrical specification. | JESD22 JA104 |
| High Temperature Exposure | <ol style="list-style-type: none"> 1. Initial measure: Spec: refer Initial spec. 2. Unpowered; 500hours @ T=+85°C. 3. Measurement at 24 ± 2 hours after test. | No Visible Damage. Fulfill the electrical specification. | MIL-STD-202 108 |
| Low Temperature Storage | <ol style="list-style-type: none"> 1. Initial measure: Spec: refer Initial spec. 2. Unpowered: 500hours @ T= -30°C. 3. Measurement at 24 ± 2 hours after test. | No Visible Damage. Fulfill the electrical specification. | MIL-STD-202 108 |
| Solderability (SMD Bottom Side) | Dipping method: <ol style="list-style-type: none"> a. Temperature: 235 ± 5°C b. Dipping time: 3 ± 0.5s | The solder should cover over 95% of the critical area of bottom side. | IEC 60384-21/22 4.10 |
| Soldering Heat Resistance (RSH) | Preheating temperature: 150 ± 10°C. Preheating time: 1~2 min. Solder temperature: 260 ± 5°C. Dipping time: 5 ± 0.5s | No Visible Damage. | IEC 60384-21/22 4.10 |
| Vibration | 5g's for 20 min., 12 cycles each of 3 orientations Note: Use 8"X5" PCB .031" thick 7 secure points on, one long side and 2 secure points at corners of opposite sides. Parts mounted within 2" from any secure point. Test from 10-2000 Hz. | No Visible Damage. | MIL-STD-202 Method 204 |
| Mechanical Shock | Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks) Peak value: 1,500g's Duration: 0.5ms Velocity change: 15.4 ft/s Waveform: Half-sine | No Visible Damage. | MIL-STD-202 Method 213 |
| Humidity Bias | <ol style="list-style-type: none"> 1. Humidity: 85% R.H., Temperature: 85 ± 2°C. 2. Time: 500 ± 24 hours. 3. Measurement at 24 ± 2hrs after testcondition. | No Visible Damage. Fulfill the electrical specification. | MIL-STD-202 Method 106 |

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| | | | |
|---------------------------|---|--|-------------------------|
| Board Flex (SMD) | <p>1. Mounting method: IR-Reflow. PCB Size (L:100 × W:40 × T:1.6mm)</p> <p>2. Apply the load in direction of the arrow until bending reaches 2 mm.</p> | <p>No Visible Damage.</p> | <p>AEC-Q200 005</p> |
| Adhesion | <p>Force of 1.8Kg for 60 seconds.</p>  | <p>No Visible Damage Magnification of 20X or greater may be employed for inspection of the mechanical integrity of the device body terminals and body/terminal junction.</p> | <p>AEC-Q200 006</p> |
| Physical Dimension | <p>Any applicable method using x10 magnification, micrometers, calipers, gauges, contour projectors, or other measuring equipment, capable of determining the actual specimen dimensions.</p> | <p>In accordance with specification.</p> | <p>JESD22 JB100</p> |

Revision History

| Revision | Date | Content |
|----------|------------|---------------|
| 1 | 2020/10/15 | New Datasheet |